

Absolute Maximum Ratings T_c = 25°C unless otherwise noted

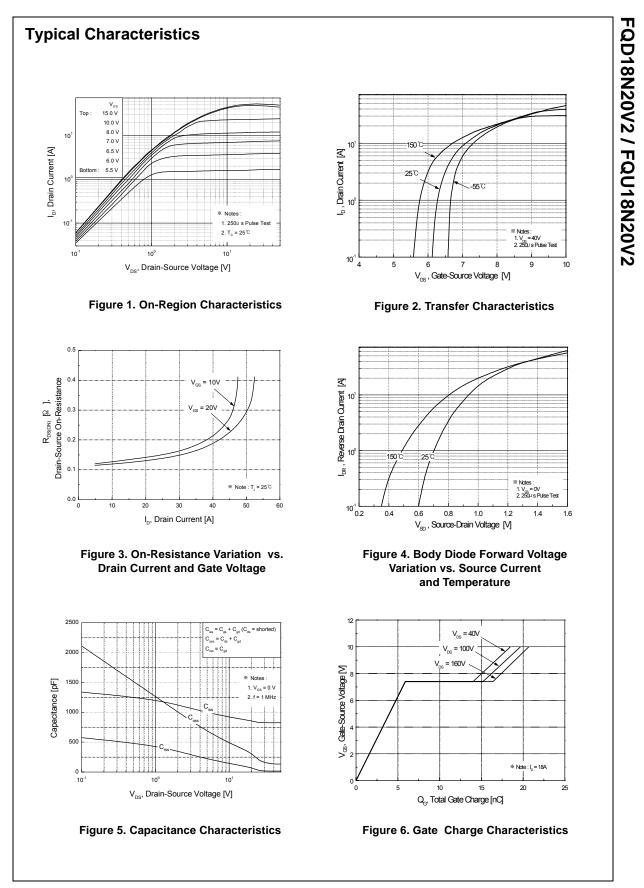
Symbol	Parameter		FQD18N20V2 / FQU18N20V2	Units
V _{DSS}	Drain-Source Voltage		200	V
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		15	А
	- Continuous (T _C = 100°C)		9.75	А
I _{DM}	Drain Current - Pulsed	(Note 1)	60	А
V _{GSS}	Gate-Source Voltage		± 30	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	340	mJ
I _{AR}	Avalanche Current	(Note 1)	15	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	8.3	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	6.5	V/ns
P _D	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		2.5	W
	Power Dissipation ($T_C = 25^{\circ}C$)		83	W
	- Derate above 25°C		0.67	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

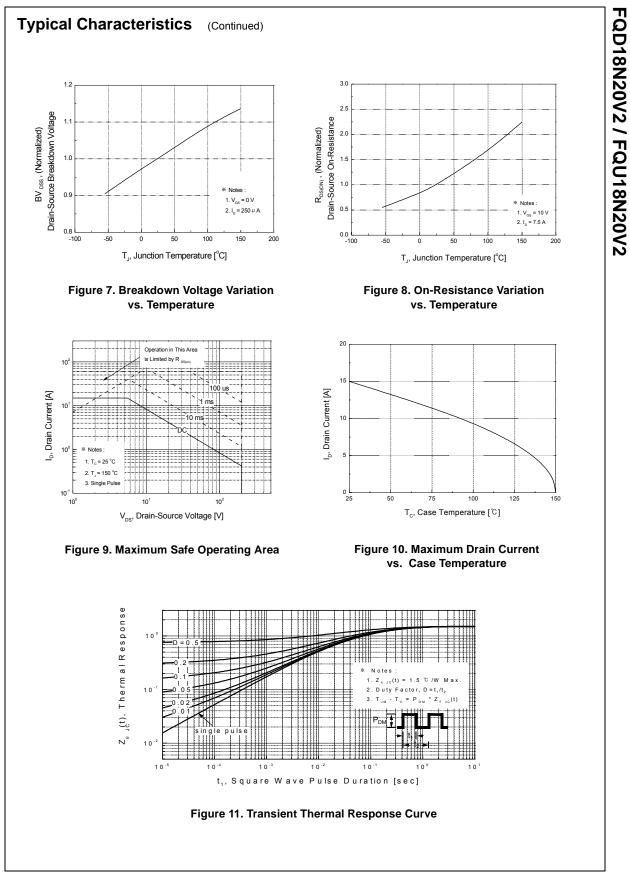
Thermal Characteristics

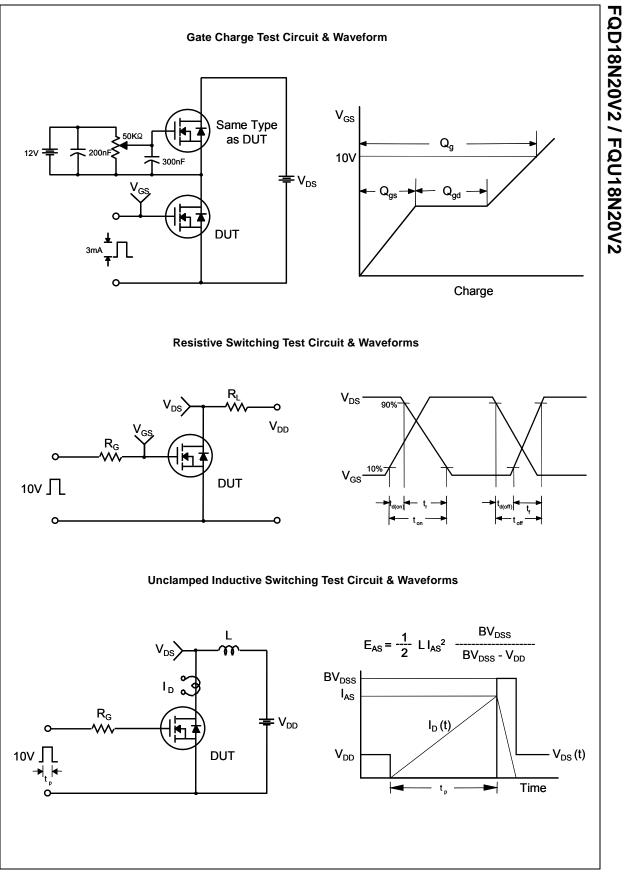
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient		110	°C/W

Off Cha BV _{DSS} ΔBV _{DSS} / ΔT _J		Test Conditions		Тур	Max	Units
BV _{DSS} ΔBV _{DSS} / ΔT _J	ractoristics					
ΔBV _{DSS} / ΔT _J	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = 250 μA	200			V
U	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu$ A, Referenced to 25°C		0.25		V/°C
	Zara Cata Valtaga Drain Current	V _{DS} = 200 V, V _{GS} = 0 V			1	μA
	Zero Gate Voltage Drain Current	V _{DS} = 160 V, T _C = 125°C			10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 30 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V			-100	nA
On Cha	racteristics					
V _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	3.0		5.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7.5 \text{ A}$		0.12	0.14	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 7.5 A (Note 4)		11		S
C _{iss}	c Characteristics Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,		830	1080	pF
C _{oss}	Output Capacitance	f = 1.0 MHz		200	260	pF
C _{rss}	Reverse Transfer Capacitance		-	25	33	pF
C _{oss}	Output Capacitance	V _{DS} = 160 V, V _{GS} = 0 V, f = 1.0 MHz		70		pF
C _{oss} eff.	Effective Output Capacitance	V_{DS} = 0V to 160 V, V_{GS} = 0 V		135		pF
	ng Characteristics					
Switchi	ng Characteristics			16	40	ns
Switchi t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 18 A,		16 133	40	ns
Switchi t _{d(on)} t _r	Turn-On Delay Time Turn-On Rise Time	V_{DD} = 100 V, I _D = 18 A, R _G = 25 Ω		133	275	ns
Switchi t _{d(on)} t _r	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time			133 38	275 85	ns ns
Switchi t _{d(on)} t _r t _{d(off)}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$R_G = 25 \Omega$ (Note 4, 5)		133	275	ns
Switchi t _{d(on)} t _r t _{d(off)} t _f Q _g	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge	$R_G = 25 \Omega$ (Note 4, 5) V _{DS} = 160 V, I _D = 18 A,		133 38 62	275 85 135	ns ns ns
Switchi t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time	$R_G = 25 \Omega$ (Note 4, 5)	 	133 38 62 20	275 85 135 26	ns ns ns nC
Switchi t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 V, I_{D} = 18 A,$ $V_{GS} = 10 V$ (Note 4, 5)	 	133 38 62 20 5.6	275 85 135 26 	ns ns nC nC
Switchi t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gs} Q _{gd}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 V, I_{D} = 18 A,$ $V_{GS} = 10 V$ (Note 4, 5) (Note 4, 5)	 	133 38 62 20 5.6	275 85 135 26 	ns ns nC nC
Switchi t _{d(on)} t _r Qg Qgs Qgd Drain-S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge ource Diode Characteristics and	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 V, I_{D} = 18 A,$ $V_{GS} = 10 V$ (Note 4, 5) (N		133 38 62 20 5.6 10	275 85 135 26 	ns ns nC nC nC
Switchi t _{d(on)} t _r t _{d(off)} t _f Q _g Q _{gd} Drain-S I _S I _S V _{SD}	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Ource Diode Characteristics an Maximum Continuous Drain-Source Diode F Drain-Source Diode Forward Voltage	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 V, I_{D} = 18 A,$ $V_{GS} = 10 V$ (Note 4, 5) (N	 	133 38 62 20 5.6 10	275 85 135 26 15	ns ns nC nC nC
Switchi t _{d(on)} t _r Qg Qgs Qgd Drain-S	Turn-On Delay Time Turn-On Rise Time Turn-Off Delay Time Turn-Off Fall Time Total Gate Charge Gate-Source Charge Gate-Drain Charge Ource Diode Characteristics an Maximum Continuous Drain-Source Diode Maximum Pulsed Drain-Source Diode F	$R_{G} = 25 \Omega$ (Note 4, 5) $V_{DS} = 160 V, I_{D} = 18 A,$ $V_{GS} = 10 V$ (Note 4, 5) (N	 	133 38 62 20 5.6 10 	275 85 135 26 15 60	ns ns nC nC nC

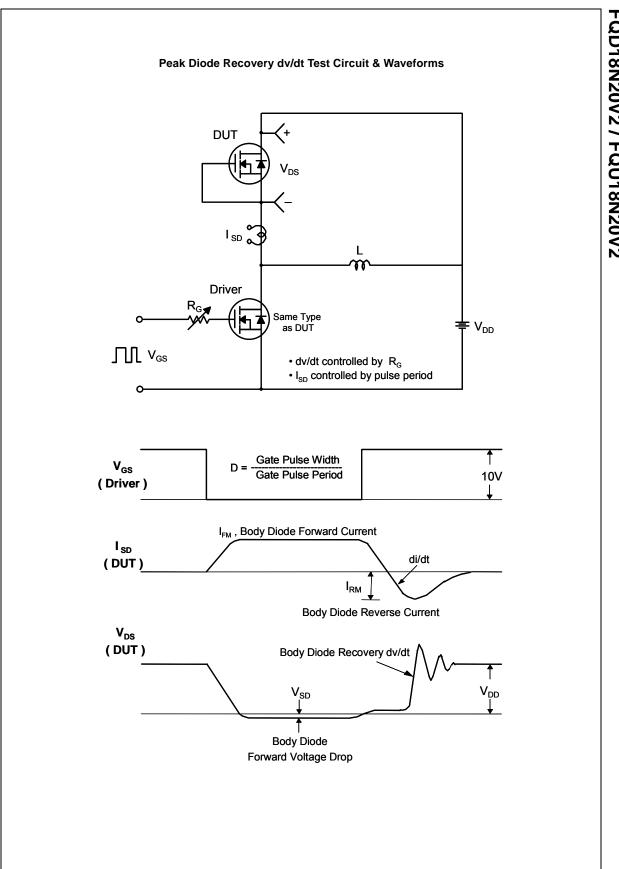
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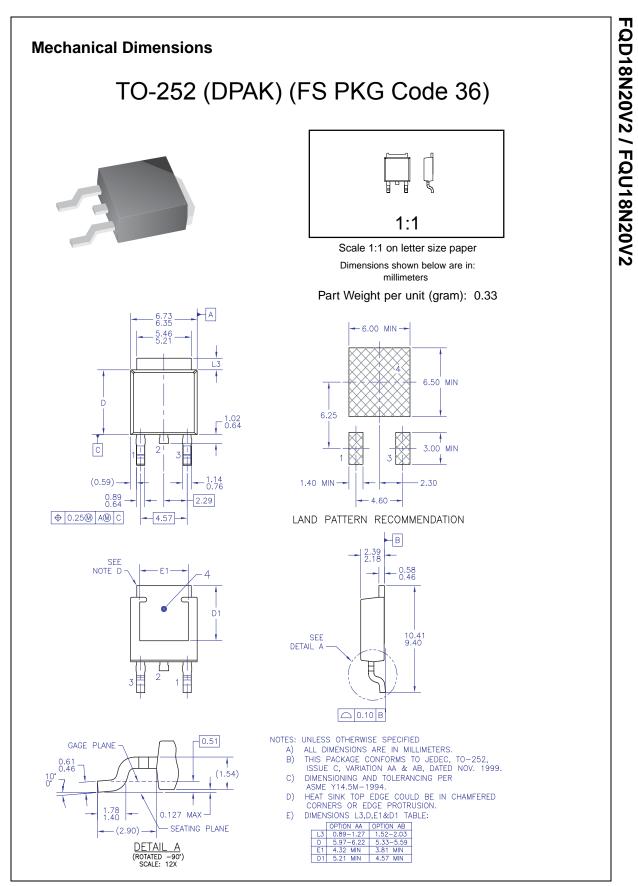




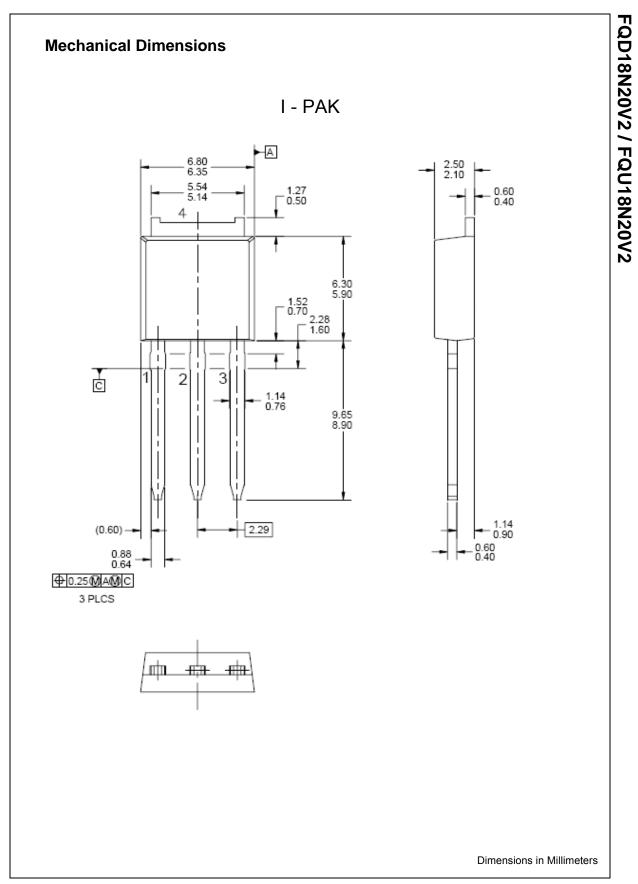
Rev. B2, January 2009



FQD18N20V2 / FQU18N20V2



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